

C0603C330J4RACTU

Aliases (C0603C330J4RAC7867) SMD Comm X7R, Ceramic, 33 pF, 5%, 16 VDC, X7R, SMD, MLCC, Temperature Stable, Class II, 0603, 0.5 mm



General Information	
Series	SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	4.8 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0603
L	1.6mm +/-0.15mm
W	0.8mm +/-0.15mm
Т	0.8mm +/-0.07mm
S	0.5mm MIN
В	0.35mm +/-0.15mm
S	0.5mm MIN

T	0.8mm +/-0.0/mm
S	0.5mm MIN
В	0.35mm +/-0.15mm
Packaging Specifications	
Packaging	T&R, 180mm, Paper Tape

Packaging Quantity

4000

Specifications	
Capacitance	33 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	5%
Voltage DC	16 VDC
Dielectric Withstanding Voltage	40 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	3.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 48 Hours
Insulation Resistance	100 GOhms

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